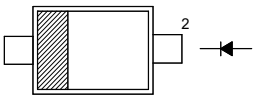
Silicon Epitaxial Planar Switching Diode

PINNING

PIN	DESCRIPTION
1	Cathode
2	Anode



Top View
Simplified outline SOD-323 and symbol

Features

- AEC-Q101 Qualified
- Fast switching
- Halogen and Antimony Free(HAF), RoHS compliant

Absolute Maximum Ratings (T_a = 25℃)

Parameter	Symbol	Value	Unit
Peak Reverse Voltage	V_{RM}	100	V
Reverse Voltage	V_R	75	V
Average Rectified Forward Current	$I_{F(AV)}$	150	mA
Forward Continuous Current	I_{FM}	300	mA
Surge Forward Current at t < 1 μs at t < 1 s	I_{FSM}	2 1	A
Power Dissipation [1)]	P_D	200	mW
Junction Temperature	T_j	150	℃
Storage Temperature Range	T_{stg}	- 55 to + 150	℃

Thermal Characteristics

Parameter	Symbol	Max.	Unit
Thermal Resistance from Junction to Ambient [1)]	$R_{\theta JA}$	625	℃/W

[1)] Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

Characteristics at T_a = 25℃

Parameter	Symbol	Min.	Max.	Unit
Reverse Breakdown Voltage at I_R = 1 μA	$V_{(BR)R}$	75	-	V
Forward Voltage at I_F = 1 mA at I_F = 10 mA at I_F = 50 mA at I_F = 150 mA	V_F	 - - - -	 0.715 0.855 1 1.25	 V
Peak Reverse Current at V_R = 75 V at V_R = 20 V at V_R = 75 V, T_J = 150 °C at V_R = 25 V, T_J = 150 °C	I_R	 - - - -	 1 25 50 30	 μA nA μA μA
Total Capacitance at V_R = 0 V, f = 1 MHz	C_T	-	2	pF
Reverse Recovery Time at I_{rr} = 0.1 X I_R , I_F = 10 mA, V_R = 6 V, R_L = 100 Ω	t_{rr}	-	4	ns

Electrical Characteristics Curves

Fig. 1 Power Derating Curve

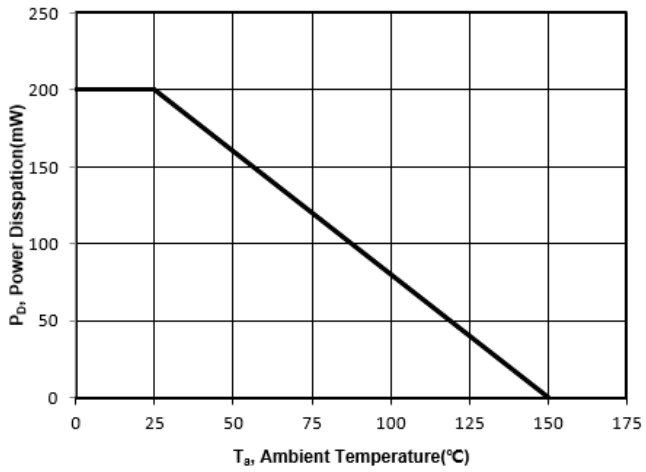


Fig. 2 Capacitance Characteristics

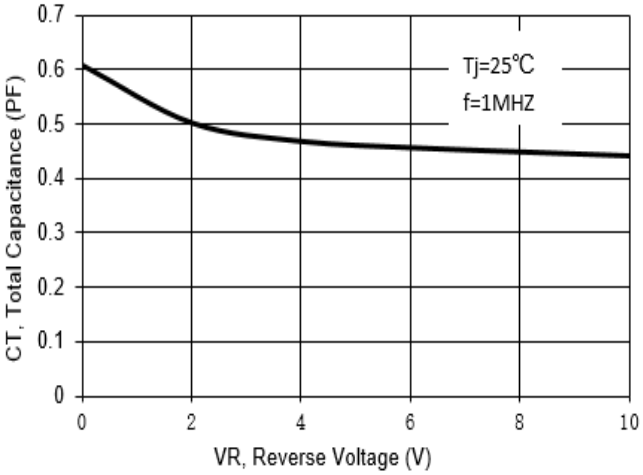


Fig. 3 Reverse Characteristics

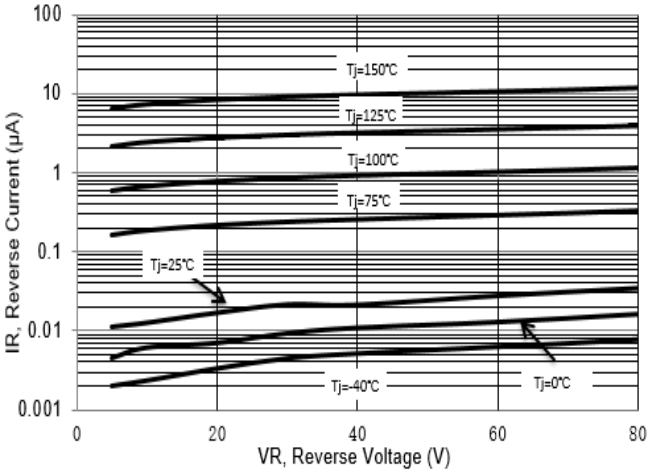
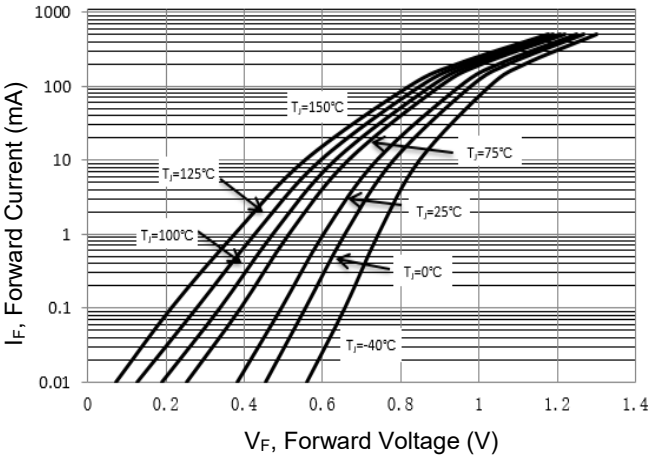
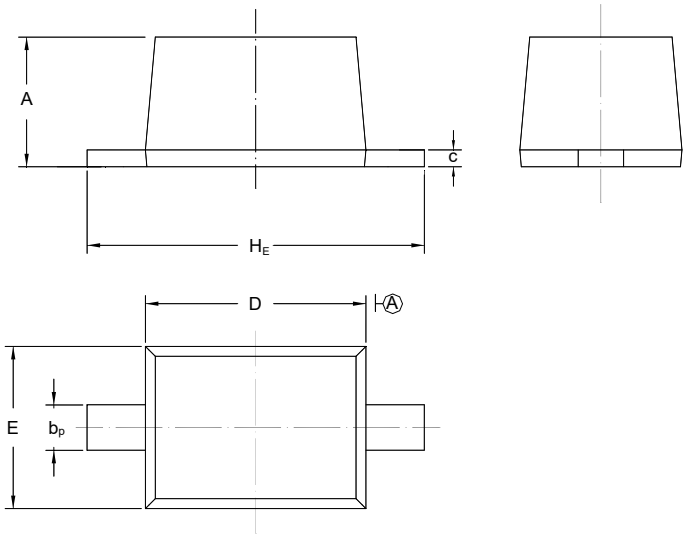


Fig. 4 Forward Characteristics



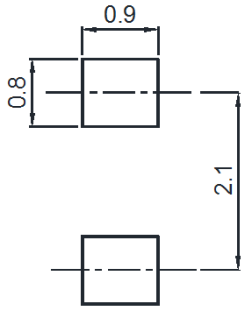
PACKAGE OUTLINE

Plastic surface mounted package; 2 leads **SOD-323**



UNIT	A	b_p	C	D	E	H_E
mm	1.10 0.80	0.40 0.25	0.15 0.10	1.80 1.60	1.35 1.15	2.80 2.30

Recommended Soldering Footprint



Packing information

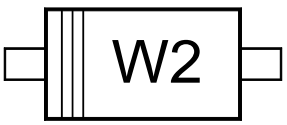
Package	Tape Width (mm)	Pitch		Reel Size		Per Reel Packing Quantity
		mm	inch	mm	inch	
SOD-323	8	4 ± 0.1	0.157 ± 0.004	178	7	3,000

Marking information

" W2 " = Part No

" III " = Cathode line

Font type: Arial



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